



Click [here](#) for the 3D model.

Dimensions

Footprint	6954
L	6.93mm +/-0.38mm
W	5.41mm +/-0.38mm
H	2.74mm +/-0.38mm
S	1.19mm +0.25/-0.13mm
F	3.05mm +/-0.13mm
K	1.22mm MIN
P	0.61mm MIN

Packaging Specifications

Packaging	T&R, 178mm
Packaging Quantity	500

General Information

Series	T497 HRA
Dielectric	MnO ₂ Tantalum
Style	SMD Chip
Description	SMD, MnO ₂ , Molded, High Reliability, Medical
Features	High Reliability, Medical
RoHS	Yes
Termination	Tin
Qualifications	CWR09/19/29 Style
AEC-Q200	No
Component Weight	590.44 mg
Notes	Note: When solder coated terminations are required, add an additional 0.38mm (0.015inch) to the tolerances for "L", "W", "H", "K", "F" and "S".
MSL	1

Specifications

Capacitance	33 uF
Capacitance Tolerance	10%
Voltage DC	25 VDC (85C), 16.75 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Humidity	85C, 85% RH, 1000 Hours, No Load
Dissipation Factor	8% 120Hz 25C
Failure Rate	C (0.01%/1000 Hrs)
Resistance	0.9 Ohms (100kHz 25C)
Ripple Current	428 mA (rms, 100kHz 25C)
Leakage Current	8.3 uA (5min 25°C)
Testing and Reliability	Standard Testing Only